













- ► PLCC2 SMD
- ➤ 3528 1.9t Series
- ► Sky White (Ice Blue)

N0W49S48Z





3528 1.9t Series







FEATURES:

• Package: Top View PLCC2 White SMD Package

Forward Current: 20mAForward Voltage (typ.): 3.2V

Luminous Intensity (typ.): 2000mcd@20mA

• Colour: Sky White (Ice Blue)

Colour Temperature (CCT): 8400~12000K

• Viewing angle: 120°

Materials:

Die: InGaN

Resin: Silicon (Yellow Diffused)

L/T Finish: Ag plated

Operating Temperature: -40~+105°C
Storage Temperature: -40~+105°C

• Grouping parameters:

Forward Voltage

Luminous Intensity

CIE Chromaticity

• Soldering methods: Reflow Soldering

Preconditioning: MSL 2a according to J-STD020

Packing: 8mm tape with max.2000/reel, ø180mm (7")

APPLICATIONS:

- Automotive
- Portable Lighting
- Commercial Lighting
- Indoor Lighting
- Backlight for LCD
- General Lighting



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I _F	30	mA
Pulse Forward Current @Duty 1/10, 0.1ms	IPF	100	mA
Reverse Voltage	V_R	5	V
Reverse Current @10V	I _R	10	μΑ
Junction Temperature	Tj	115	°C
Electrostatic Discharge (HBM)	ESD	6000	V
Operating Temperature	T_{OPR}	-40~+105	°C
Storage Temperature	T _{STG}	-40~+105	°C
Soldering Temperature	T _{SOL}	260	°C
Thermal Resistance Junction to Solder Point	R _{th}	150	°C/W

Electrical & Optical Characteristics (Ta=25°C)

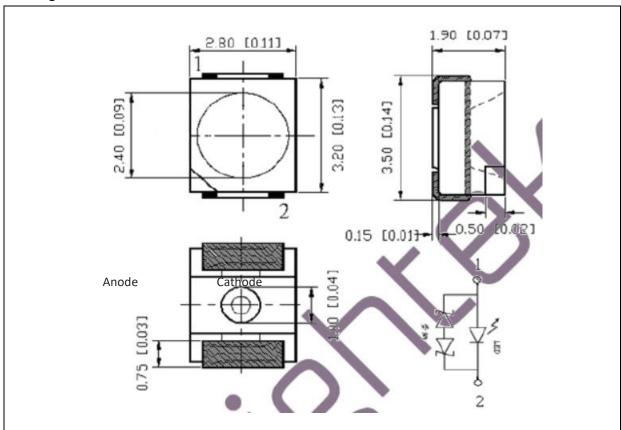
Parameter	Symbol	Values			Unit	Test	
Parameter	Зуппоп	Min.	Тур.	Max.	Offic	Condition	
Forward Voltage	V _F	2.8		3.6	V	I _F =20mA	
Luminous Intensity	lv	1650	2000		mcd	I _F =20mA	
Chromaticity	Х		0.2930			I _F =20mA	
Coordinates	Υ		0.2670				
Colour Temperature	ССТ	8400	9900	12000	К	I _F =20mA	
Viewing Angle	2θ _{1/2}		120		deg	I _F =20mA	

 $^{1. \}qquad \text{Luminous Intensity } (\Phi_{\text{V}}) \pm 10\%, \text{ Forward Voltage } (V_{\text{F}}) \pm 0.1\text{V}, \text{ Colour Coordinate: } \pm 0.005, \text{ Viewing Angle} (2\theta 1/2) \pm 5\%, \text{ CRI } \pm 1\%, \text{ CRI } \pm 1\%,$



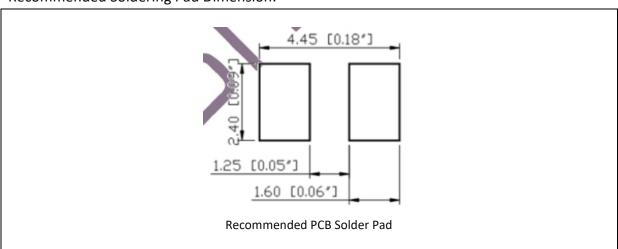
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 20mA):

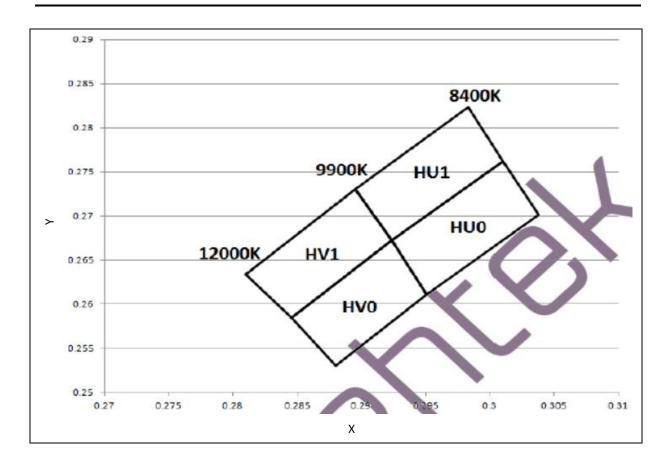
Code	Min.	Max.	Unit
В	2.8	2.9	
С	2.9	3.0	
D	3.0	3.1	
E	3.1	3.2	V
F	3.2	3.3	V
G	3.3	3.4	
Н	3.4	3.5	
I	3.5	3.6	

Luminous Intensity Classifications (I_F = 20mA):

Code	Min.	Max.	Unit
4	1650	1850	
5	1850	2050	mad
6	2050	2250	mcd
7	2250	2450	



CIE CHROMATICITY DIAGRAM:

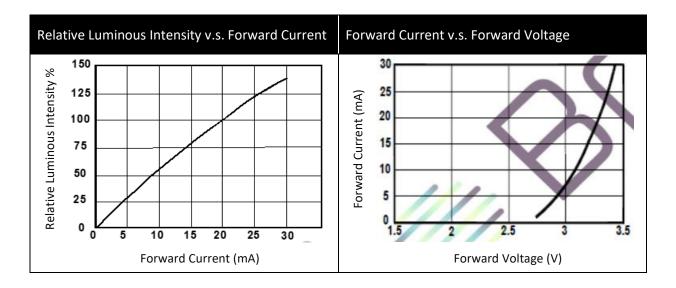


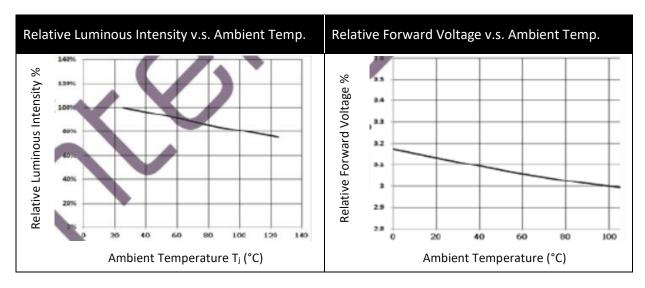
Chromaticity Coordinates Classifications (IF = 20mA):

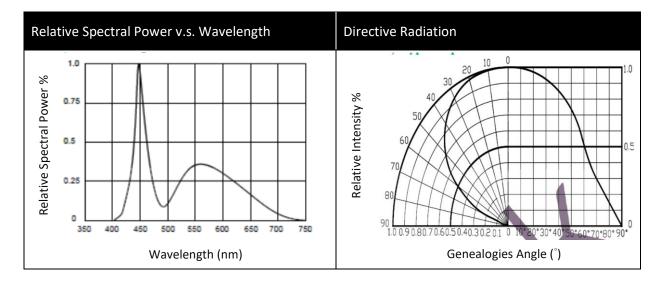
	1	1	2		3		4	
	Х	Υ	Х	Υ	Х	Υ	Х	Υ
HU1	0.2895	0.2730	0.2924	0.2672	0.3010	0.2762	0.2983	0.2823
HV1	0.2810	0.2634	0.2846	0.2585	0.2924	0.2672	0.2895	0.2730
HU0	0.2924	0.2672	0.2951	0.2611	0.3038	0.2701	0.3010	0.2762
HV0	0.2846	0.2585	0.2880	0.2530	0.2951	0.2611	0.2924	0.2672



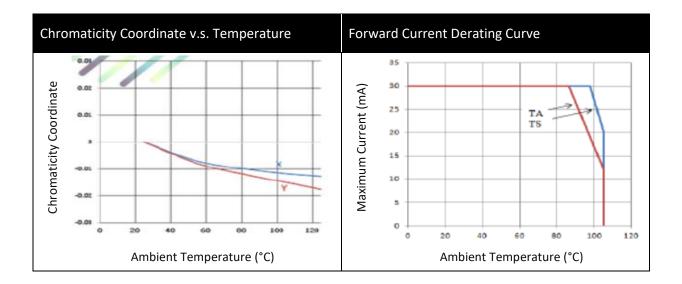
ELECTRO-OPTICAL CHARACTERISTICS:







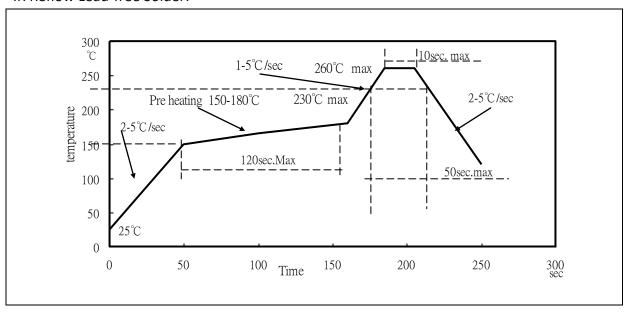






RECOMMENDED SOLDERING PROFILE:

IR Reflow Lead-free Solder:



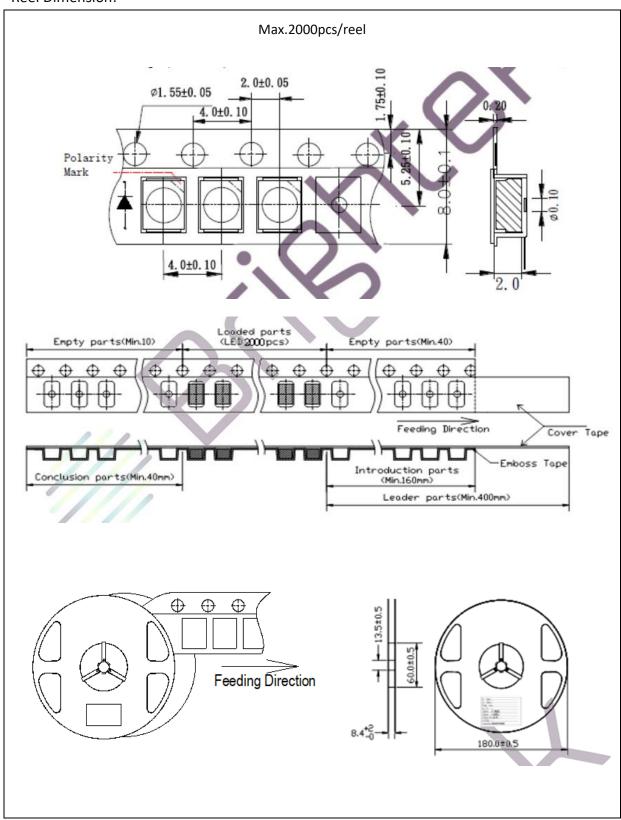
Note:

- 1. Recommended soldering temperature: 240°C. The maximum soldering temperature should be limited to 260°C.
- 2. Maxima reflow soldering: 3 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking.

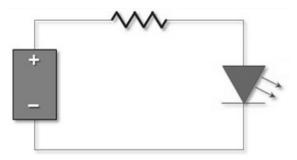
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 6hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	21/05/2019	Datasheet set-up.
A1.1	04/06/2022	New datasheet format.